

AMENDMENTS TO SPECIFICATION

Please amend page 8, line 22 to page 4, line 11, as follows:

With reference to FIG. 3, there is shown the flow diagram of the third example of the present invention. The method for manufacturing a flexible panel of the present example will be illustrated as follows. The first substrate 10 having a plurality of functional switches or conducting lines 20 formed thereon is provided first. The functional switches are thin film transistors in the present example. Next, the second substrate 30 is bonded on the functional switches or conducting lines 20, and then the first substrate 10 is thinned to a predetermined thickness to form the thinned first substrate 10'. Afterwards, ~~the a removable~~ fifth substrate 70 is adhered on the thinned first substrate 10' and subsequently the second substrate 30 is removed. Next, a plurality of light valves, light-emitters, or conducting layers 21 is formed on the functional switches or conducting lines 20, and then the fifth substrate 70 is removed. Finally, the surface of the whole substrate is coated with a flexible polymer layer 40.